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## HiPerRF ${ }^{\text {TM }}$

Power MOSFETs

## F-Class: MegaHertz Switching

N-Channel Enhancement Mode
Avalanche Rated
Low $\mathrm{Q}_{\mathrm{g}}$, Low Intrinsic $\mathrm{R}_{\mathrm{g}}$
High dV/dt, Low $\mathrm{t}_{\mathrm{rr}}$

| Symbol | Test Conditions | Maximum Ratings |  |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {DSs }}$ | $\mathrm{T}_{j}=25^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ | 500 V |  |
| $\mathrm{V}_{\text {DGR }}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{GS}}=1 \mathrm{M} \Omega$ | 500 V |  |
| $\mathrm{V}_{\text {Gss }}$ | Continuous | $\pm 20 \quad \mathrm{~V}$ |  |
| $\mathrm{V}_{\text {GSM }}$ | Transient | $\pm 30 \quad \mathrm{~V}$ |  |
| $\mathrm{I}_{\mathrm{D} 25}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 55 A |  |
| $\mathrm{I}_{\mathrm{DM}}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$, Pulse Width Limited by $\mathrm{T}_{\text {JM }}$ | 220 A |  |
| $\mathrm{I}_{\text {AR }}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 55 A |  |
| $\mathrm{E}_{\text {AS }}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 3 J |  |
| dv/dt | $\begin{aligned} & \mathrm{I}_{\mathrm{S}} \leq \mathrm{I}_{\mathrm{DM}}, \mathrm{di} / \mathrm{dt} \leq 100 \mathrm{~A} / \mu \mathrm{s}, \mathrm{~V}_{\mathrm{DD}} \leq \mathrm{V}_{\mathrm{DSS}} \\ & \mathrm{~T}_{\mathrm{J}} \leq 150^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{G}}=2 \Omega \end{aligned}$ | 10 | V/ns |
| $\mathrm{P}_{\mathrm{D}}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 560 | W |
| $\mathrm{T}_{\mathrm{J}}$ |  | $-55 \ldots+150$ | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {JM }}$ |  | 150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ |  | $-55 \ldots+150$ | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{L}}$ | 1.6 mm (0.062 in.) from Case for 10 s | 300 | ${ }^{\circ}{ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {SoLD }}$ | Plastic Body for 10s | 260 |  |
| $\mathrm{M}_{\mathrm{d}}$ | Mounting Torque (TO-264) | 1.13/10 | Nm/lb.in. |
| $\mathrm{F}_{\mathrm{c}}$ | Mounting Force (PLUS247) | 20.. $120 / 4.5 . .27$ | $\mathrm{N} / \mathrm{lb}$. |
| Weight | $\begin{aligned} & \hline \text { TO-264 } \\ & \text { PLUS247 } \end{aligned}$ | $\begin{array}{r} 10 \\ 6 \end{array}$ | g g |


$V_{\text {DSs }}=500 \mathrm{~V}$
$\mathrm{I}_{\mathrm{D} 25}=55 \mathrm{~A}$
$\mathrm{R}_{\mathrm{DS}(\mathrm{on})} \leq 85 \mathrm{~m} \Omega$
$\mathrm{t}_{\mathrm{rr}} \leq 250 \mathrm{~ns}$

TO-264 (IXFK)


PLUS247 (IXFX)

$G=$ Gate $\quad D \quad=$ Drain
$S=$ Source $\quad T A B=$ Drain

## Features

- RF capable Mosfets
- Rugged polysilicon gate cell structure
- Double metal process for low gate resistance
- Unclamped Inductive Switching (UIS) rated
- Low package inductance - easy to drive and to protect
- Fast intrinsic rectifier


## Applications

- DC-DC converters
- Switched-mode and resonant-mode power supplies, $>500 \mathrm{kHz}$ switching
- DC choppers
- Pulse generation
- Laser drivers


## Advantages

- PLUS $247^{\text {TM }}$ package for clip or spring mounting
- Space savings
- High power density



## Source-Drain Diode

| Symbol Test Conditions ( $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$, Unless Otherwise Specified) |  | Characteristic Values |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |
| $\mathrm{I}_{\text {s }}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}$ |  |  | 55 | A |
| $\mathrm{I}_{\text {SM }}$ | Repetitive, Pulse Width Limited by TJM |  |  | 220 | A |
| $\mathrm{v}_{\text {sD }}$ | $\mathrm{I}_{\mathrm{F}}=25 \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$, Note 1 |  |  | 1.5 |  |
| $t_{r r}$ <br> $\mathrm{Q}_{\mathrm{RM}}$ <br> $I_{\text {BM }}$ | $\begin{aligned} & I_{F}=25 \mathrm{~A},-\mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s} \\ & \mathrm{~V}_{\mathrm{R}}=100 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V} \end{aligned}$ |  | 1 10 | 250 | $\begin{aligned} & \text { ns } \\ & \mu \mathrm{C} \end{aligned}$ |

Note: 1. Pulse test, $\mathrm{t} \leq 300 \mu \mathrm{~s}$, duty cycle $\mathrm{d} \leq 2 \%$
2. See IXFN55N50F Datasheet for Characteristic Curves

## ADVANCE TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.


PLUS 247 ${ }^{\text {TM }}$ (IXFX) Outline

$\begin{array}{ll}\text { Terminals: } & 1 \text { - Gate } \\ & 2-\text { Drain (Collector) } \\ & 3-\text { Source (Emitter) }\end{array}$

|  | 4 - Drain (Collector) |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| Dim. | Millimeter |  | Inches |  |
|  | Min. | Max. | Min. | Max. |
| A | 4.83 | 5.21 | . 190 | . 205 |
| $\mathrm{A}_{1}$ | 2.29 | 2.54 | . 090 | . 100 |
| $\mathrm{A}_{2}$ | 1.91 | 2.16 | . 075 | . 085 |
| b | 1.14 | 1.40 | . 045 | . 055 |
| $\mathrm{b}_{1}$ | 1.91 | 2.13 | . 075 | . 084 |
| $\mathrm{b}_{2}$ | 2.92 | 3.12 | . 115 | . 123 |
| C | 0.61 | 0.80 | . 024 | . 031 |
| D | 20.80 | 21.34 | . 819 | . 840 |
| E | 15.75 | 16.13 | . 620 | . 635 |
| e | 5.45 | BSC | . 215 | BSC |
| L | 19.81 | 20.32 | . 780 | . 800 |
| L1 | 3.81 | 4.32 | . 150 | . 170 |
| Q | 5.59 | 6.20 | . 220 | 0.244 |
| R | 4.32 | 4.83 | . 170 | . 190 |



4 - Drain (Collector)

Fig. 1. Output Characteristics at $25^{\circ} \mathrm{C}$


Fig. 3. $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ vs. Drain Current


Fig. 5. Drain Current vs. Case Temperature


Fig. 2. Output Characteristics at $125^{\circ} \mathrm{C}$


Fig. 4. $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ vs. $\mathrm{T}_{\mathrm{J}}$


Fig. 6. Admittance Curves


Fig. 7. Gate Charge Characteristic Curve


Fig. 8. Capacitance Curves


Fig. 9. Source Current vs. Source to Drain Voltage


Fig. 10. Thermal Impedance


